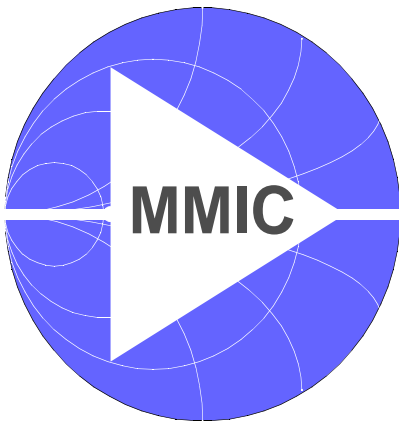


BGA428

BGA428 High Gain, Low Noise
Amplifier



Wireless
Silicon Discretes



Never stop thinking.

Edition 2002-03-26

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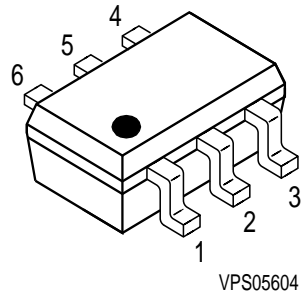
BGA428**Data sheet****Revision History: 2002-03-26**Previous Version: 2000-11-15

| Page | Subjects (major changes since last revision) |
|------|--|
| 4 | dot size for pin 1 package marking increased |
| | |
| | |
| | |
| | |

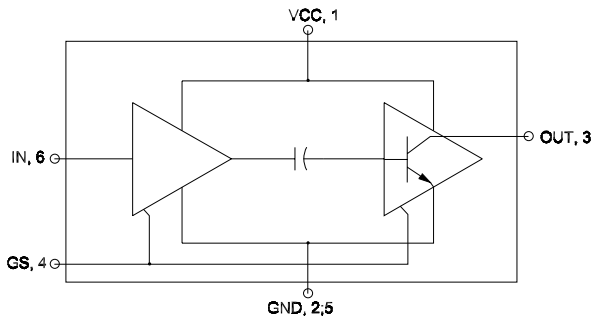
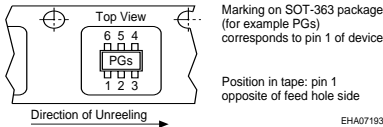
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Features

- High gain, $G_{MA}=20\text{dB}$ at 1.8GHz
- Low noise figure, $NF=1.4\text{dB}$ at 1.8GHz
- Prematched
- Ideal for GSM, DCS1800, PCS1900
- Open collector output
- Typical supply voltage: 2.4-3V
- SIEGET[®]-45 technology



Tape loading orientation



ESD: Electrostatic discharge sensitive device, observe handling precaution!

| Type | Package | Marking | Chip |
|--------|---------|---------|-------|
| BGA428 | SOT363 | PGs | T0527 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|-------------|--------------|-------------|
| Device voltage | V_{CC} | 4 | V |
| Total Device Current ³⁾ | I_{tot} | 12 | mA |
| Voltage at pin <i>Out</i> | V_{Out} | 4 | V |
| Current into pin <i>In</i> | I_{IN} | 0.5 | mA |
| Voltage at pin <i>GS</i> | V_{GS} | 3.5 | V |
| Total power dissipation, $T_s < 125^{\circ}C$ ¹⁾ | P_{tot} | 50 | mW |
| Junction temperature | T_j | 150 | $^{\circ}C$ |
| Operating temperature range | T_{OP} | -40 ..+85 | $^{\circ}C$ |
| Storage temperature range | T_{STG} | -65 ... +150 | $^{\circ}C$ |
| Thermal resistance: junction-soldering point | $R_{th JS}$ | 220 | K/W |
| Input power ²⁾ | P_{IN} | 8 | dBm |

Notes:

All Voltages refer to GND-Node

¹⁾ T_s is measured on the ground lead at the soldering point

²⁾ Valid for a) $Z_L=50\Omega$ and $Z_S=50\Omega$, $V_{CC}=2.7V$, $V_{OUT}=2.7V$, $V_{GS}=0.0V$, $GND=0.0V$
and b) $Z_L=50\Omega$ and $Z_S=50\Omega$, $V_{CC}=0.0V$, $V_{OUT}=0.0V$, $V_{GS}=2.7V$, $GND=0.0V$

³⁾ I_{tot} = Current into OUT + Current into VCC

Electrical Characteristics at $T_A=25^{\circ}C$ (measured in test circuit specified in fig. 1)

$V_{CC}=2.7V$, Frequency=1.8GHz, unless otherwise specified

| Parameter | Symbol | min. | typ. | max. | Unit |
|---|------------|------|------|------|------|
| Maximum available power gain | G_{MA} | | 20 | | dB |
| Noise figure ($Z_S=50\Omega$) | NF | | 1.4 | | dB |
| Input power at 1dB gain compression | P_{-1dB} | | -19 | | dBm |
| Input third order intercept point | IIP_3 | | -9 | | dBm |
| Total device current | I_{tot} | | 8.2 | | mA |
| Insertion loss in gain-step-mode $V_{CC}=0.0V$, $V_{CTRL}=2.7V$, $R_{CTRL}=3k\Omega$ | L_{GS} | | 13.5 | | dB |

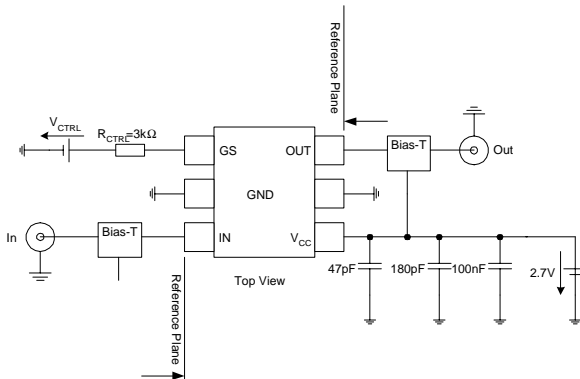


Fig. 1: Test Circuit for Electrical Characteristics and S-Parameter

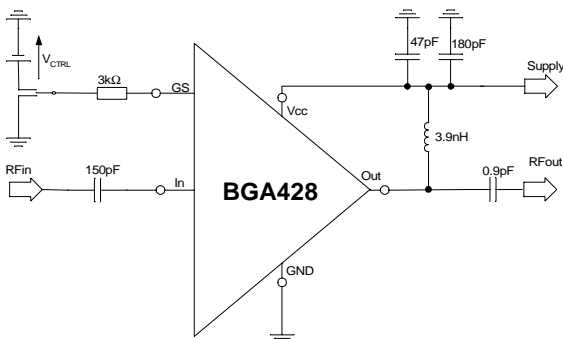


Fig. 2: Application Circuit for 1850MHz

S-Parameter at 2.7V (see Electrical Characteristics for conditions)

| Freq. [GHz] | S11 Mag | S11 Ang | S21 Mag | S21 Ang | S12 Mag | S12 Ang | S22 Mag | S22 Ang |
|-------------|---------|---------|---------|---------|---------|---------|---------|---------|
| 0.100 | 0.6756 | -31.7 | 58.775 | -19.6 | 0.0005 | 153.5 | 0.9491 | -3.9 |
| 0.200 | 0.5936 | -53.6 | 47.806 | -43.1 | 0.0014 | 138.4 | 0.9327 | -6.3 |
| 0.300 | 0.5150 | -71.4 | 39.232 | -59.5 | 0.0021 | 119.0 | 0.9174 | -8.3 |
| 0.400 | 0.4587 | -86.6 | 32.740 | -71.8 | 0.0028 | 104.9 | 0.9035 | -10.3 |
| 0.600 | 0.4004 | -110.7 | 23.868 | -89.6 | 0.0042 | 105.9 | 0.8807 | -14.0 |
| 0.800 | 0.3743 | -129.1 | 18.509 | -103.2 | 0.0063 | 94.3 | 0.8593 | -17.7 |
| 1.000 | 0.3743 | -143.0 | 14.825 | -114.5 | 0.0082 | 92.4 | 0.8352 | -21.4 |
| 1.200 | 0.3816 | -154.5 | 12.288 | -124.7 | 0.0093 | 87.2 | 0.8116 | -25.1 |
| 1.400 | 0.3922 | -164.4 | 10.353 | -134.2 | 0.0110 | 85.3 | 0.7865 | -28.7 |
| 1.600 | 0.4086 | -172.4 | 8.879 | -143.2 | 0.0132 | 79.4 | 0.7597 | -32.2 |
| 1.800 | 0.4265 | -178.9 | 7.732 | -151.4 | 0.0141 | 79.4 | 0.7309 | -36.0 |
| 1.900 | 0.4314 | 178.8 | 7.214 | -155.2 | 0.0146 | 76.1 | 0.7199 | -37.5 |
| 2.000 | 0.4371 | 176.1 | 6.771 | -159.1 | 0.0150 | 77.0 | 0.7097 | -39.1 |
| 2.200 | 0.4505 | 171.2 | 5.976 | -166.6 | 0.0169 | 75.2 | 0.6791 | -42.3 |
| 2.400 | 0.4640 | 167.2 | 5.298 | -173.5 | 0.0181 | 73.2 | 0.6593 | -45.6 |
| 3.000 | 0.4935 | 155.9 | 3.935 | 167.0 | 0.0217 | 68.3 | 0.5925 | -53.3 |
| 4.000 | 0.5181 | 141.2 | 2.605 | 139.2 | 0.0282 | 65.1 | 0.5284 | -64.9 |
| 5.000 | 0.5202 | 126.9 | 1.911 | 113.6 | 0.0319 | 62.2 | 0.4829 | -75.1 |
| 6.000 | 0.5128 | 110.0 | 1.479 | 89.9 | 0.0489 | 56.0 | 0.4323 | -81.7 |

Application Circuit Characteristics (measured in test circuit specified in fig. 2)

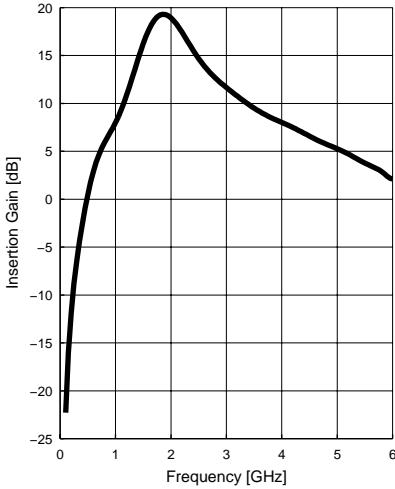
 TA=25°C, V_{CC}=2.7V, Frequency=1.85GHz, unless otherwise specified

| Parameter | Symbol | typ. | Unit |
|--|--------------|------|------|
| Insertion power gain | $ S_{21} ^2$ | 19 | dB |
| Noise Figure ($Z_S=50\Omega$) | NF | 1.4 | dB |
| Input Power at 1dB Gain Compression | P_{-1dB} | -19 | dBm |
| Input Third Order Intercept Point | IIP_3 | -9 | dBm |
| Total Device Current | I_{tot} | 8.2 | mA |
| Insertion Loss in Gain-Step-Mode V _{CC} =0.0V, V _{CTRL} =2.7V, R _{CTRL} =3kΩ | L_{GS} | 13.5 | dB |

The following data refers to the application circuit given in fig. 2

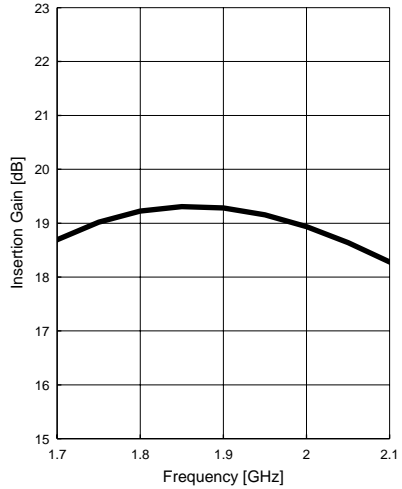
Power Gain $|S_{21}|^2=f(f)$

$V_{CC} = 2.7V, V_{Out} = 2.7V$



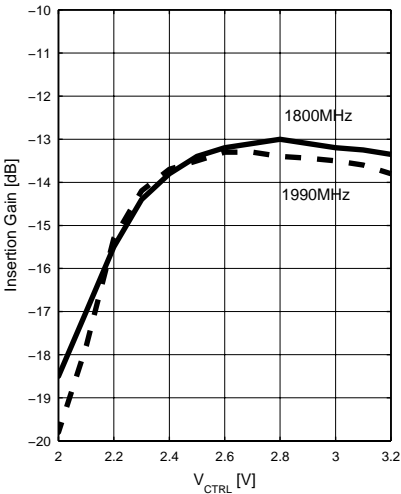
Power Gain $|S_{21}|^2=f(f)$

$V_{CC} = 2.7V, V_{Out} = 2.7V$



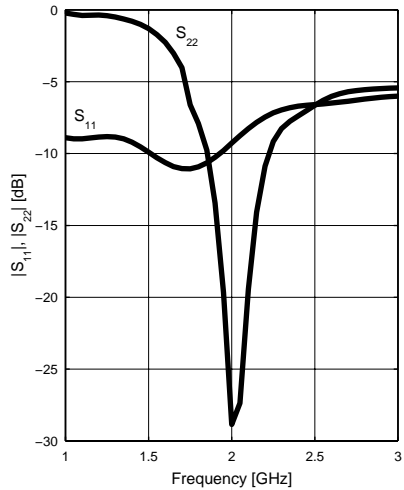
Off-Gain $|S_{21}|^2=f(V_{CTRL})$

$V_{CC} = 0.0V, V_{Out} = 0.0V, R_{CTRL} = 2.7k\Omega$

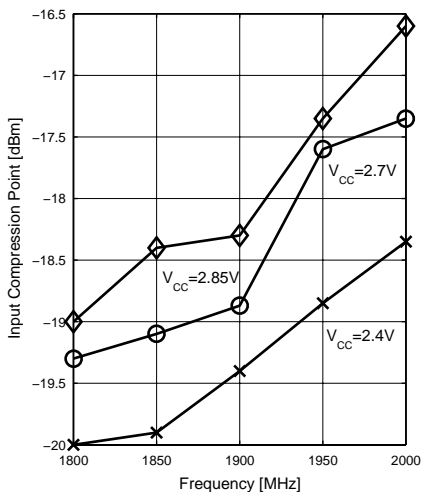


Matching $|S_{11}|, |S_{22}|=f(f)$

$V_{CC} = 2.7V, V_{Out} = 2.7V$

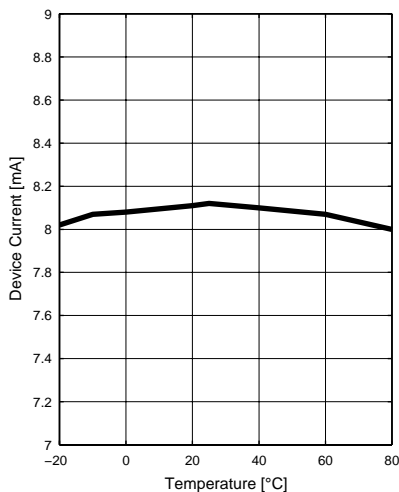


Input Compression Point $P_{-1dB}=f(f)$



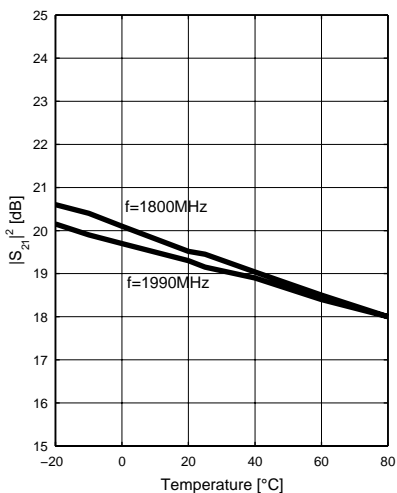
Device Current $I=f(\vartheta)$

$V_{CC}=2.7V, V_{Out}=2.7V$

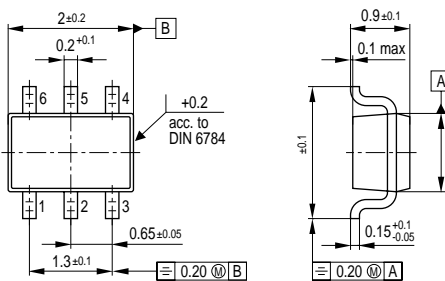


Insertion Gain $|S_{21}|^2=f(\vartheta)$

$V_{CC}=2.7V, V_{Out}=2.7V$



Package Outline



GPS05604